

TRANSMITTAL FORM

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Sept. 11, 2003 (Date of Deposit)

Mail Stop: Patent Application Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Attorney Doc. #: __67 Mailing Date: __Se

67,200-1092 Sept. 11, 2003

Dear Sir:

Transmitted herewith for filing is the patent application of:

Inventor(s):

Bor-Wen Chan

Fang-Cheng Chen Yuan-Hung Chiu

Hsien-Kuang Chiu Han-Jan Tao

For: Sidewall Polymer Deposition Method for Forming a Patterned Microelectronic Layer

Submitted herewith are:

- X 1 sheet(s) of formal drawings
- X A Declaration for patent application under CFR 1.63 and 1.68

The filing fee has been calculated as shown below:

	No. Filed	No. Extra	Small Entity Fee	Large Entity Fee	Total
Basic Fee		,	\$375.00	\$750.00	\$750.00
Total Claims	20x20	0 x	\$9.00	\$18.00	\$0
Indep. Claims	3-3	0 x	\$42.00	\$84.00	\$0
Multiple Dep. Clms.			\$140.00	\$280.00	\$0
Assign. Rec. Fee		1	\$40.00	\$40.00	\$40.00
TOTAL		1			\$790.00

Mailing Date: Sept 11, 2003 Attorney Docket No.:

_X	Attached is a Credit Card Payment Form for the sum of \$					
<u>X</u>	Charge Visa Credit Card No A duplicate copy of this transn	4756 8461 9	the sum of \$_	790.00		

X The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Visa Credit Card No. _4756.8461 A duplicate copy of this sheet is enclosed.

Any additional filing fees required under 37 CFR 1.6
Any patent application processing fees under 37 CFR 1.17

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RWT/kd Enclosures